

BAP50-04W General purpose PIN diode Rev. 2 – 25 October 2016

Product data sheet

1. Product profile

1.1 General description

Two planar PIN diodes in series configuration in a SOT323 small SMD plastic package.

1.2 Features and benefits

- Two elements in series configuration in a small SMD plastic package
- Low diode capacitance
- Low diode forward resistance
- AEC-Q101 qualified

1.3 Applications

General RF application

2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
1	anode		
2	cathode	3	3
3	common connection		1 2 aaa-025249

3. Ordering information

Table 2.Ordering information

Type number	Package		
	Name	Description	Version
BAP50-04W	-	plastic surface-mounted package; 3 leads	SOT323



4. Marking

Table 3. Marking	
Type number	Marking code
BAP50-04W	6W-

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Values are specified per diode.

Symbol	Parameter	Conditions	Min	Max	Unit
V _R	continuous reverse voltage		-	50	V
I _F	continuous forward current		-	50	mA
P _{tot}	total power dissipation	T _s = 90 °C	-	240	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

6. Thermal characteristics

Table 5.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-sp)}	thermal resistance from junction to soldering point		250	K/W

7. Characteristics

Table 6.Characteristics

 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _F	forward voltage	I _F = 50 mA		-	0.95	1.1	V
V _R	reverse voltage	I _R = 10 μA		50	-	-	V
I _R	reverse current	V _R = 50 V		-	-	100	nA
C _d	diode capacitance	f = 1 MHz; see <u>Figure 1</u>					
		V _R = 0 V		-	0.45	-	pF
		V _R = 1 V		-	0.35	0.6	pF
		V _R = 5 V		-	0.30	0.5	pF
r _D	diode forward resistance	f = 100 MHz; see Figure 2					
		I _F = 0.5 mA	<u>[1]</u>	-	25	40	Ω
		I _F = 1 mA	<u>[1]</u>	-	14	25	Ω
		I _F = 10 mA	<u>[1]</u>	-	3	5	Ω
τ∟	charge carrier life time	when switched from I _F 10 mA to I _R 6mA; R _L 100 Ω ; measured at I _R 3 mA		-	1.05	-	μS
L _S	series inductance	I _F = 10 mA; f = 100 MHz		-	1.60	-	nH

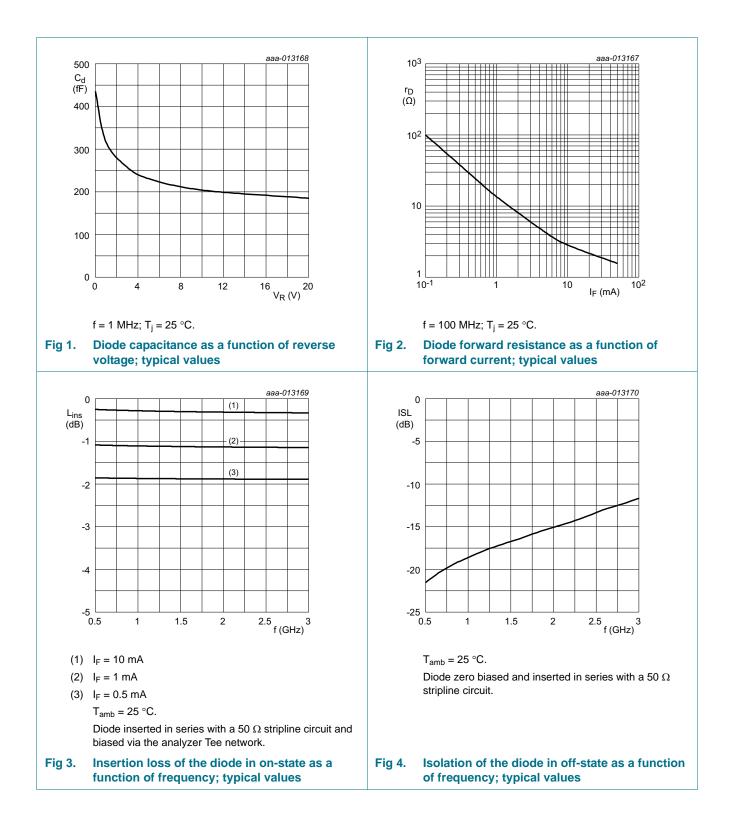
[1] Guaranteed on AQL basis: inspection level S4, AQL 1.0.

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8. Package outline

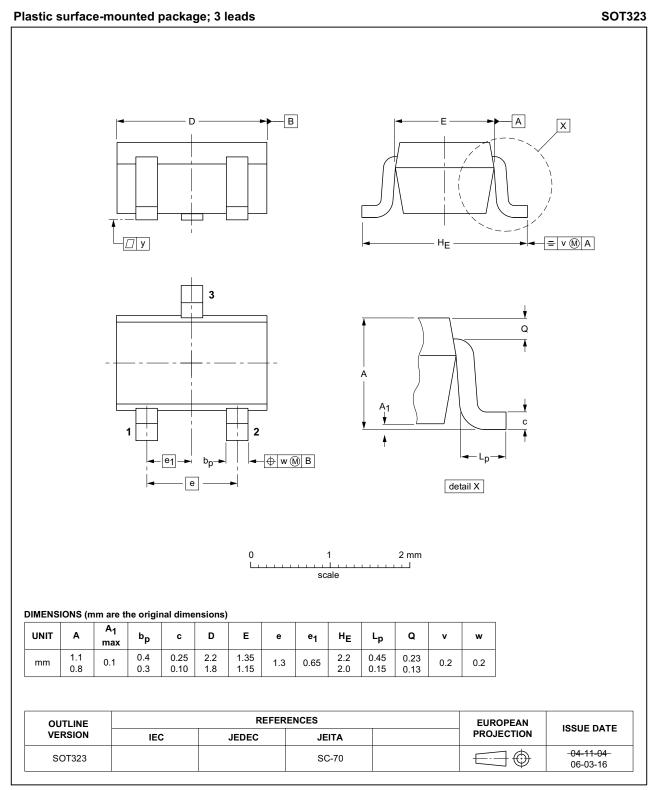


Fig 5. Package outline SOT323

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9. Abbreviations

Table 7. Abbreviations					
Acronym	Description				
AQL	Acceptable Quality Level				
PIN	P-type, Intrinsic, N-type				
SMD	Surface Mounted Device				
RF	Radio Frequency				
S4	Special inspection level 4				

10. Revision history

Table 8.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAP50-04W v.2	20161025	Product data sheet	-	BAP50-04W_1
Modification:	AEC-Q101-qualified			
BAP50-04W_1	20010129	Product data sheet	-	-

11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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